



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

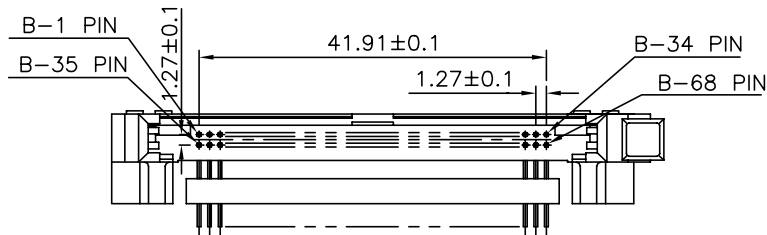
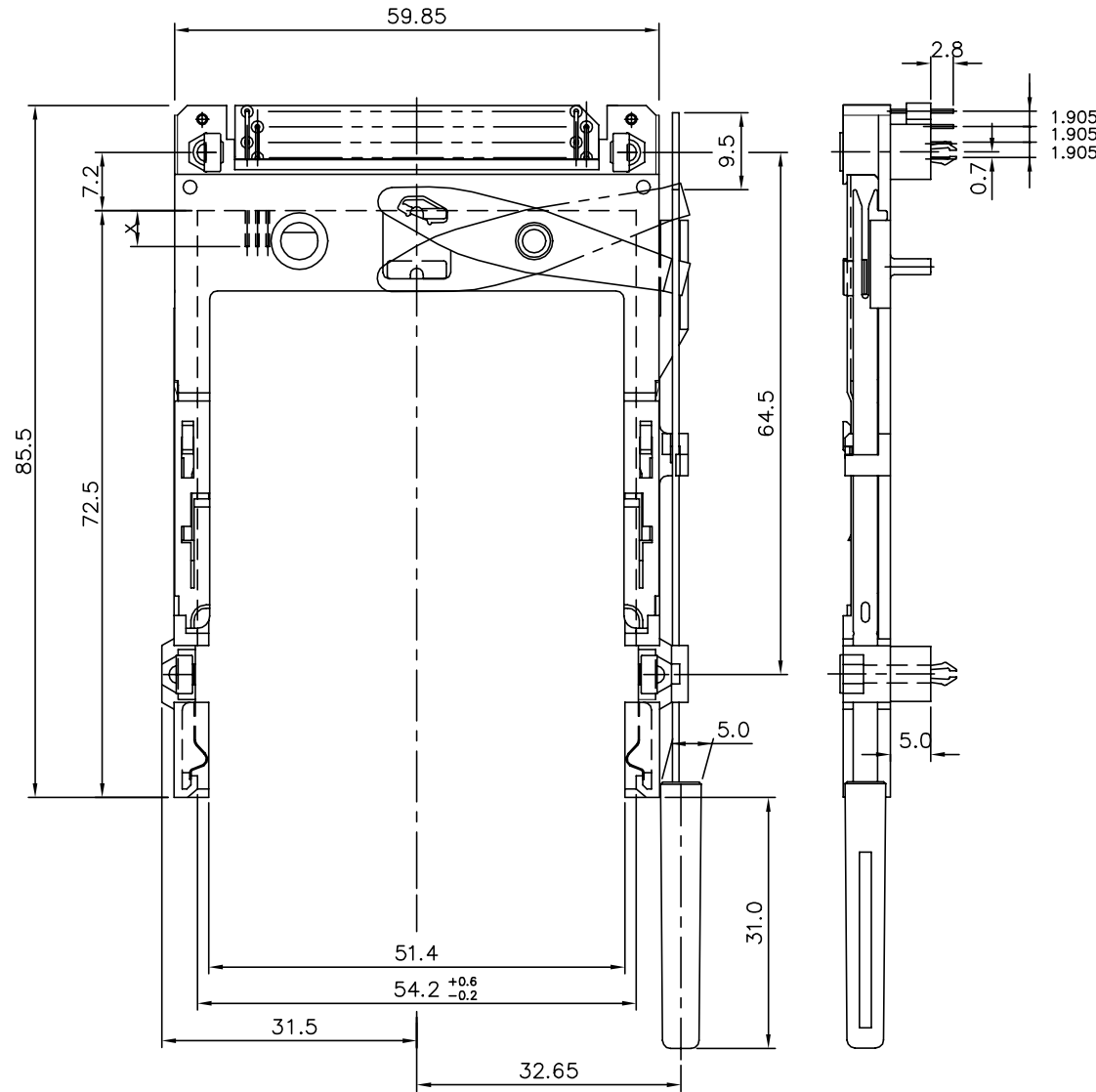


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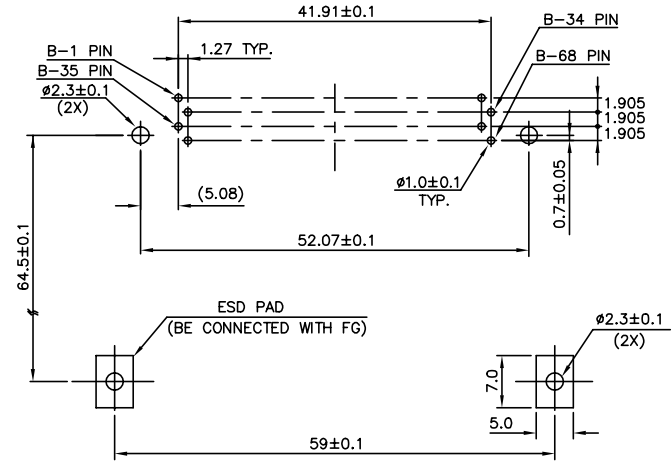
PRODUCT NO.
 10112445-050HAH/050HAHLF



NOTES:

- EJECT FORCE : 3.5 Kg MAX.
- EJECT TRAVEL: 8.0mm
- MATERIAL
 - HEADER ASS'Y :
 - PLASTIC : HOUSING ...HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 - : LOCATOR ...HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 - PIN : COPPER ALLOY
 - EJECT MECHANISM ASS'Y :
 - PLASTIC : GUIDE: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 - : PUSH BUTTON: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 - PLATE : STAINLESS
 - EMI CONTACT: PHOSPHOR BRONZE
- FINISH (PIN)
 - UNDER PLATING : 0.5µm MIN. Ni
 - CONTACT AREA : 0.076 µm MIN. GOLD
 - SOLDER TAIL(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
 - SOLDER TAIL(LEAD FREE OPTION): 2.5µm MIN. PURE TIN
- DIM "X"

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
- IF LEAD FREE P/N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- LEAD FREE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBED IN GS-22-008
- IF LEAD FREE P/N. PACKAGING MEETS GS-14-920 SPECIFICATION
- PRODUCT SPEC: 110-263



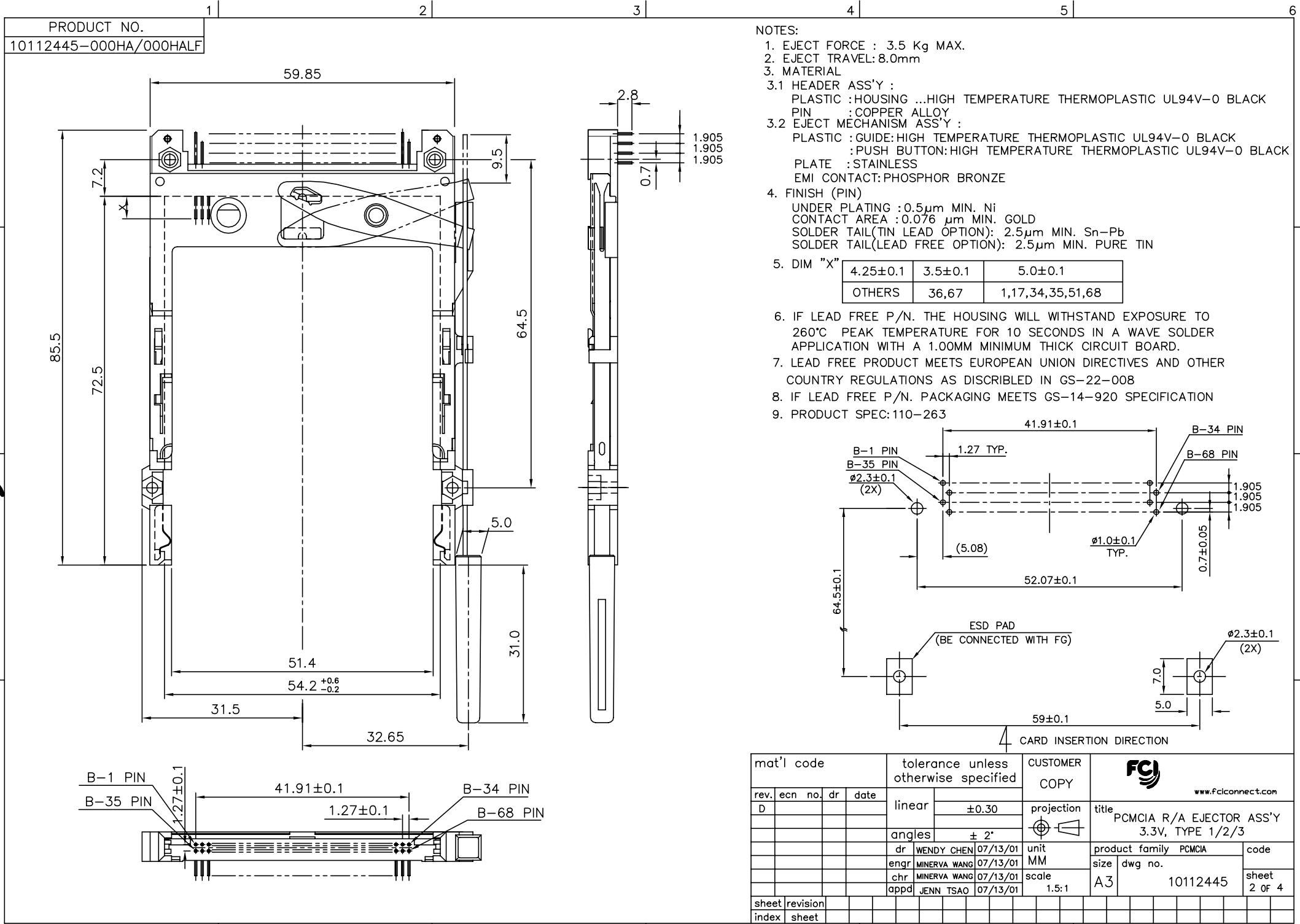
4 CARD INSERTION DIRECTION

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		FCJ www.fciconnect.com	
rev.	ecn no.	dr	date	linear	±0.30	projection	title PCMCIA R/A EJECTOR ASS'Y 3.3V, TYPE 1/2/3
A	N10-0032	SH	02/03/10				
B	N10-0062	SH	03/24/10	angles	± 2°		product family PCMCIA size dwg no. 10112445
C	ELX-N-011456	ZK	04/14/12				
D	ELX-N-011827	ZK	06/01/12	dr	WENDY CHEN 01/21/99	unit MM	code 1 OF 4
				enrg	LEIF SHEN 01/21/99	scale 1.5:1	
				chr	JOSEPH HSIA 01/21/99		
				appd	JENN TSAO 01/21/99		
sheet	revision	D	D	D	D		
index	sheet	1	2	3	4		

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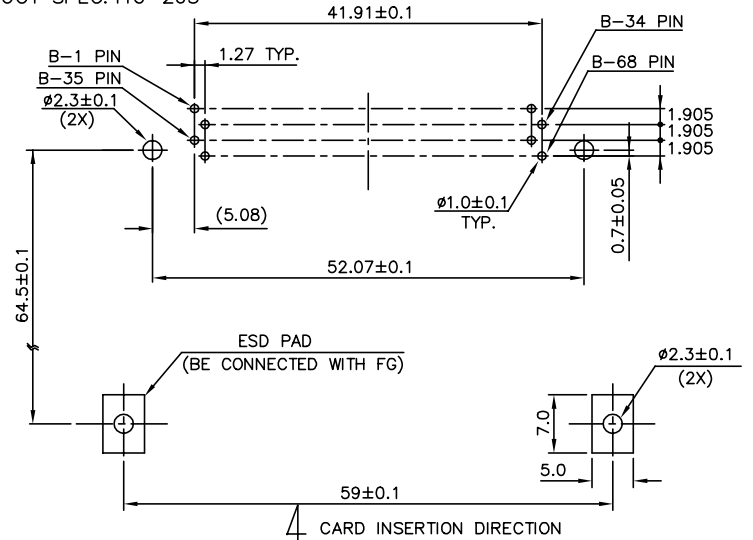
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 - MATERIAL
 - HEADER ASS'Y :
 - PLASTIC : HOUSING ...HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 - PIN : COPPER ALLOY
 - EJECT MECHANISM ASS'Y :
 - PLASTIC : GUIDE: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 - : PUSH BUTTON: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 - PLATE : STAINLESS
 - EMI CONTACT: PHOSPHOR BRONZE
 - FINISH (PIN)
 - UNDER PLATING : 0.5µm MIN. Ni
 - CONTACT AREA : 0.076 µm MIN. GOLD
 - SOLDER TAIL (TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
 - SOLDER TAIL (LEAD FREE OPTION): 2.5µm MIN. PURE TIN

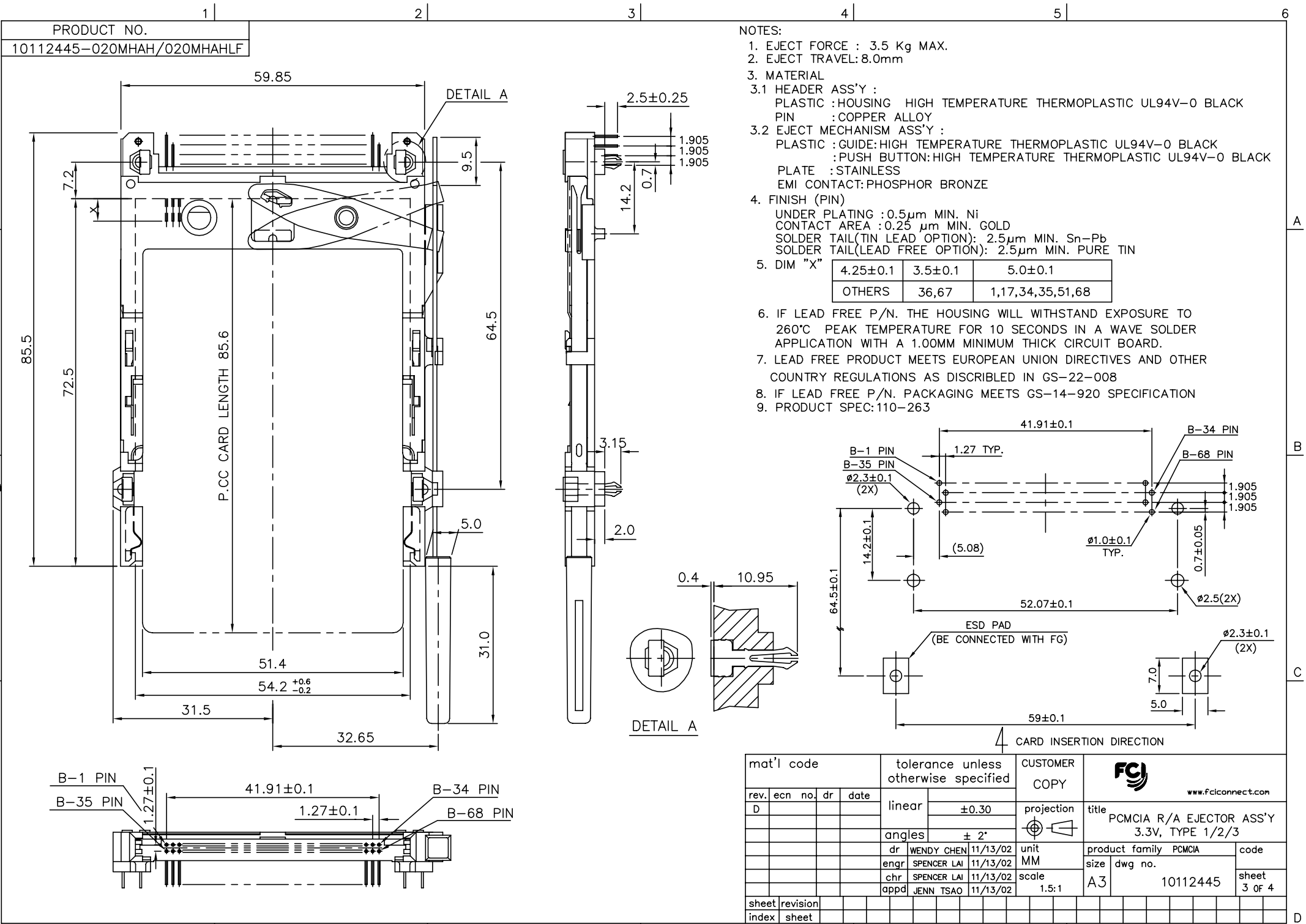
5. DIM "X"	4.25±0.1	3.5±0.1	5.0±0.1
	OTHERS	36,67	1,17,34,35,51,68

- IF LEAD FREE P/N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
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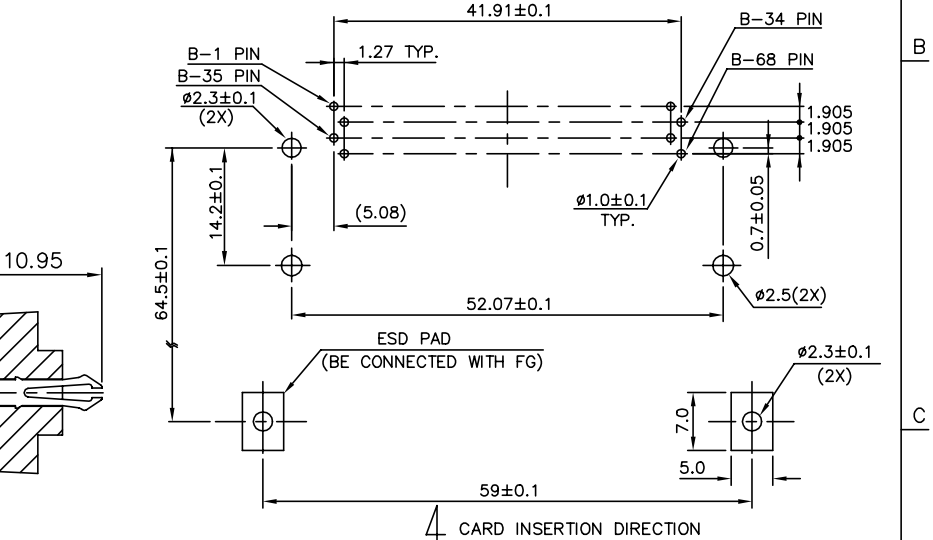
mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		FCJ www.fciconnect.com	
rev.	ecn no.	dr	date	linear	±0.30	projection	title
D				angles	± 2'	⊕	PCMCIA R/A EJECTOR ASS'Y 3.3V, TYPE 1/2/3
				dr	WENDY CHEN 07/13/01	unit	product family
				engr	MINERVA WANG 07/13/01	MM	PCMCIA
				chr	MINERVA WANG 07/13/01	scale	size
				appd	JENN TSAO 07/13/01	1.5:1	dwg no.
sheet	revision						code
index	sheet						10112445
							sheet 2 OF 4

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- NOTES:
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 - MATERIAL
 - HEADER ASS'Y :
 PLASTIC : HOUSING HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 PIN : COPPER ALLOY
 - EJECT MECHANISM ASS'Y :
 PLASTIC : GUIDE: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 : PUSH BUTTON: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
 PLATE : STAINLESS
 EMI CONTACT: PHOSPHOR BRONZE
 - FINISH (PIN)
 UNDER PLATING : 0.5µm MIN. Ni
 CONTACT AREA : 0.25 µm MIN. GOLD
 SOLDER TAIL (TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
 SOLDER TAIL (LEAD FREE OPTION): 2.5µm MIN. PURE TIN
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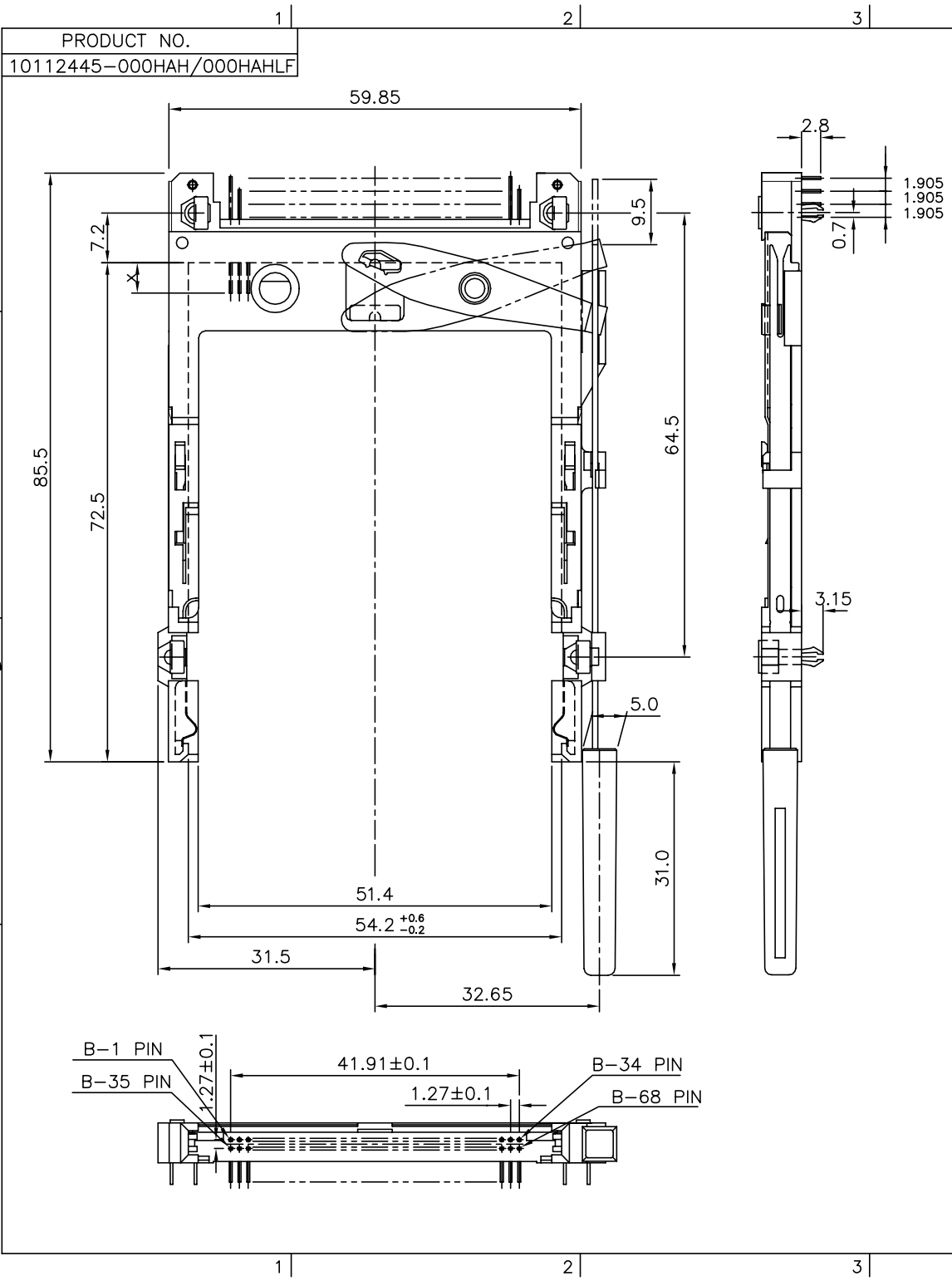


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rev.	ecn no.	dr	date	linear	±0.30	projection	title
D				angles	± 2°		PCMCIA R/A EJECTOR ASS'Y 3.3V, TYPE 1/2/3
		dr	WENDY CHEN	11/13/02	unit	MM	product family
		enrg	SPENCER LAI	11/13/02	scale	1.5:1	PCMCIA
		chr	SPENCER LAI	11/13/02	size	A3	dwg no.
		appd	JENN TSAO	11/13/02	sheet	10112445	code
sheet	revision						
index	sheet						sheet 3 OF 4

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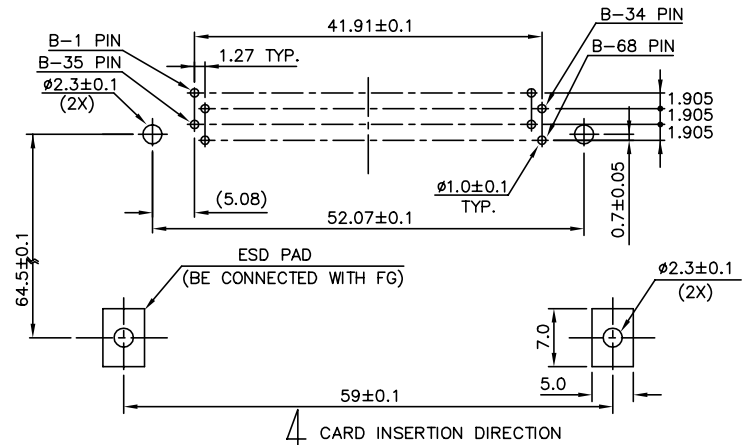
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NOTES:

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2. EJECT TRAVEL: 8.0mm
3. MATERIAL
 - 3.1 HEADER ASS'Y : HOUSING: PLASTIC, HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
PIN : COPPER ALLOY
 - 3.2 EJECT MECHANISM ASS'Y : PLASTIC : GUIDE: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
: PUSH BUTTON: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
PLATE : STAINLESS
EMI CONTACT: COPPY ALLOY
4. FINISH (PIN)
 - UNDER PLATING : 0.5µm MIN. Ni
 - CONTACT AREA : 0.076 µm MIN. GOLD
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rev.	ecn no.	dr	date	linear	±0.30	projection	title PCMCIA R/A EJECTOR ASS'Y 3.3V, TYPE 1/2/3
D				angles	± 2'		
				dr	WENDY CHEN 07/13/01	unit	product family PCMCIA
				enrg	MINERVA WANG 07/13/01	MM	
				chr	MINERVA WANG 07/13/01	scale	size dwg no.
				appd	JENN TSAO 07/13/01	1.5:1	
sheet	revision						code 10112445
index	sheet						